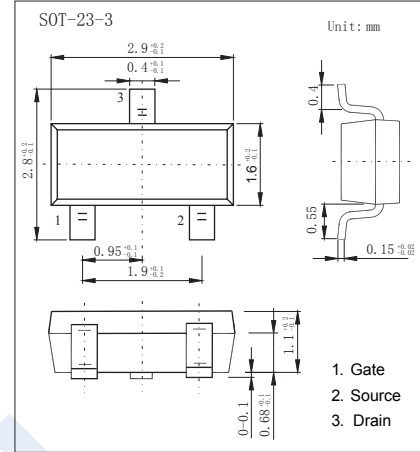
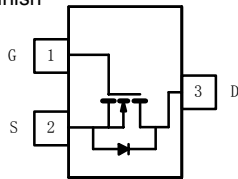


N-Channel MOSFET

SI2312DS-HF (KI2312DS-HF)

■ Features

- $V_{DS} (V) = 20V$
- $I_D = 4.9 A (V_{GS} = 4.5V)$
- $R_{DS(ON)} < 33m\Omega (V_{GS} = 4.5V)$
- $R_{DS(ON)} < 40m\Omega (V_{GS} = 2.5V)$
- $R_{DS(ON)} < 51m\Omega (V_{GS} = 1.8V)$
- Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage	V_{DS}	20		V	
Gate-Source Voltage	V_{GS}	± 8			
Continuous Drain Current *1	I_D	$T_a = 25^\circ C$	4.9	3.77	A
		$T_a = 70^\circ C$	3.9	3.0	
Pulsed Drain Current *2	I_{DM}	15			
Avalanche Current *2	I_{AS}	15		mJ	
Single Avalanche Energy	E_{AS}	11.25			
Power Dissipation *1	P_D	$T_a = 25^\circ C$	1.25	0.75	W
		$T_a = 70^\circ C$	0.8	0.48	
Thermal Resistance.Junction- to-Ambient *1 $t \leq 5$ sec	R_{thJA}	100		$^\circ C/W$	
		Steady State			166
Thermal Resistance.Junction-to-Foot	R_{thJF}	50			
Junction Temperature	T_J	150		$^\circ C$	
Storage Temperature Range	T_{stg}	-55 to 150			

*1 Surface Mounted on 1" x 1" FR4 Board.

*2 Pulse width limited by maximum junction temperature

N-Channel MOSFET

SI2312DS-HF (KI2312DS-HF)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μ A, V _{GS} =0V	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	μ A
		V _{DS} =20V, V _{GS} =0V, Ta=70°C			75	
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250 μ A	0.45		0.85	V
On-State Drain Current *1	I _{D(on)}	V _{DS} ≥ 10 V, V _{GS} = 4.5 V	15			A
Static Drain-Source On-Resistance *1	R _{DS(on)}	V _{GS} =4.5V, I _D =5.0A			33	mΩ
		V _{GS} =2.5V, I _D =4.5A			40	
		V _{GS} =1.8V, I _D =4.0A			51	
Forward Transconductance *1	g _{FS}	V _{DS} =15V, I _D =5.0A		40		S
Total Gate Charge	Q _g	V _{GS} =4.5V, V _{DS} =10V, I _D =5.0A		11.2	14	nC
Gate Source Charge	Q _{gs}			1.4		
Gate Drain Charge	Q _{gd}			2.2		
Turn-On DelayTime	t _{d(on)}	I _D =1.0A, V _{DS} =10V, V _{GEN} =4.5V R _L =10Ω, R _G =6Ω		15	25	ns
Turn-On Rise Time	t _r			40	60	
Turn-Off DelayTime	t _{d(off)}			48	70	
Turn-Off Fall Time	t _f			31	45	
Body Diode Reverse Recovery Time	t _{rr}	I _F = 1.0A, di/dt= 100A/μ s		13	25	
Maximum Body-Diode Continuous Current	I _S				1.0	A
Diode Forward Voltage	V _{SD}	I _S =1.0A, V _{GS} =0V		0.8	1.2	V

*1 Pulse test: PW ≤ 300us duty cycle ≤ 2%.

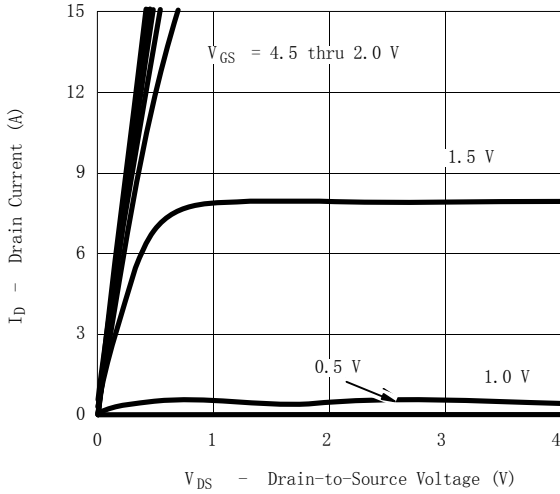
■ Marking

Marking	C2* _F
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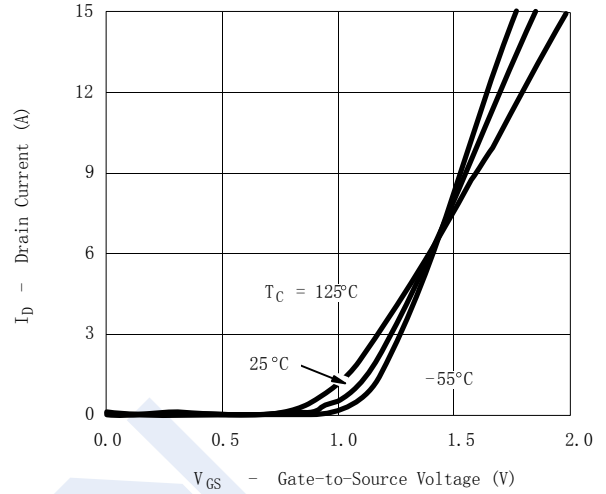
N-Channel MOSFET

SI2312DS-HF (KI2312DS-HF)

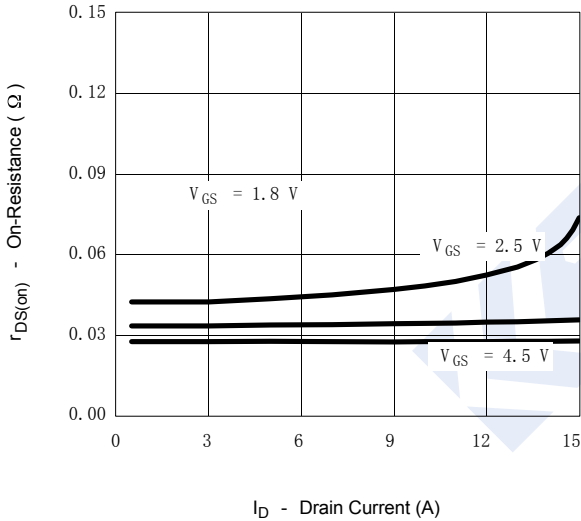
■ Typical Characteristics
Output Characteristics



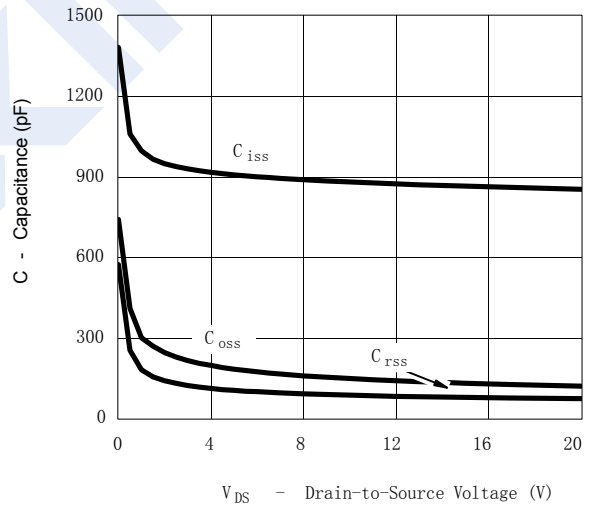
Transfer Characteristics



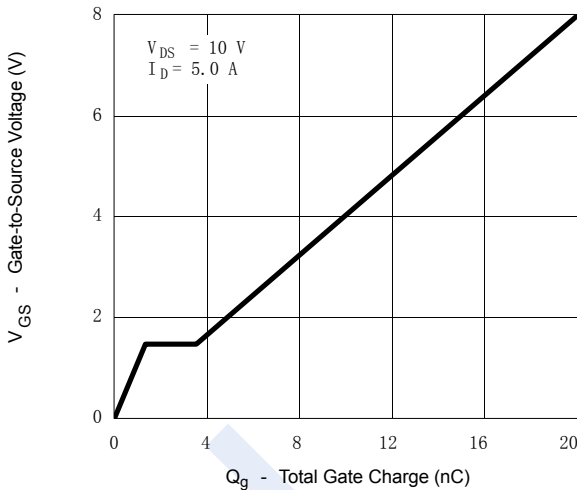
On-Resistance vs. Drain Current



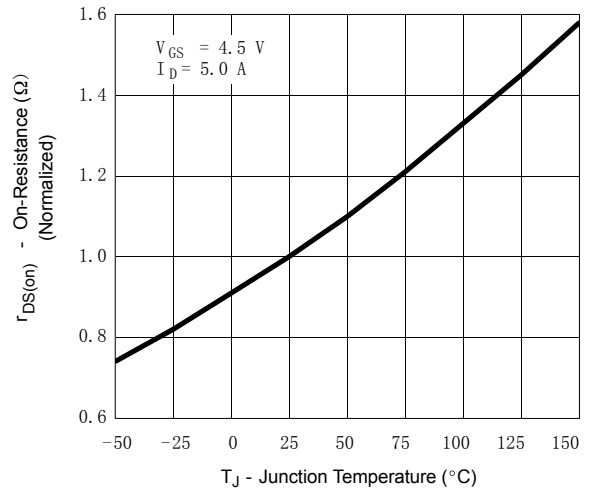
Capacitance



Gate Charge



On-Resistance vs. Junction Temperature



N-Channel MOSFET SI2312DS-HF (KI2312DS-HF)

■ Typical Characteristics

